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Zytel[®] HTNFR52G30NH NC010

HIGH PERFORMANCE POLYAMIDE RESIN

Zytel[®] HTN high performance polyamide resins feature high retention of properties upon exposure to elevated temperature, to high moisture, and to harsh chemical environments. Polymer families and grades of Zytel[®] HTN are tailored to optimise performance as well as processability.

Typical applications with Zytel[®] HTN include demanding applications in the automotive, electrical and electronics, domestic appliances, and construction industries.

Zytel[®] HTNFR52G30NH NC010 is a 30% glass reinforced, flame retardant high performance polyamide resin. It is also a PPA resin and it uses a non-halogenated flame retardant.

Product information

Resin Identification Part Marking Code Part Marking Code ISO designation	PA6T/66-GF30FR(40) >PA6T/66-GF30FR(40)< >PPA-GF30FR< ISO 16396-PA6T/66,GF30 FR(40),M1F1GNF		ISO 1043 ISO 11469 SAE J1344 M1F1GNR,S10-100
Rheological properties	dry/cond.		
Moulding shrinkage, parallel Moulding shrinkage, normal	0.3/- 1.1/-	% %	ISO 294-4, 2577 ISO 294-4, 2577
Typical mechanical properties	dry/cond.		
Tensile Modulus Stress at break Strain at break Flexural Modulus Flexural Strength Charpy impact strength, 23°C Charpy notched impact strength, 23°C Charpy notched impact strength, -30°C Poisson's ratio	10500/10500 150/130 2.2/2 9000/10000 230/200 45/40 40/35 8/7 7/7 0.34/0.34	MPa MPa % MPa kJ/m² kJ/m² kJ/m² kJ/m²	ISO 527-1/-2 ISO 527-1/-2 ISO 527-1/-2 ISO 178 ISO 178 ISO 179/1eU ISO 179/1eU ISO 179/1eA ISO 179/1eA
Thermal properties Melting temperature, 10°C/min Melting temperature, first heat Temp. of deflection under load, 1.8 MPa Ball pressure test CLTE, Parallel, -40-23°C Coeff. of linear therm. expansion, parallel CLTE, Parallel, 55-160°C CLTE, Normal, -40-23°C Coeff. of linear therm. expansion, normal	dry/cond. 312/* 310/* 283/* 290/- 20/* 20/* 20/* 60/*	°C °C °C E-6/K E-6/K E-6/K E-6/K E-6/K	ISO 11357-1/-3 ISO 11357-1/-3 ISO 75-1/-2 IEC 60695-10-2 ISO 11359-1/-2 ISO 11359-1/-2 ISO 11359-1/-2 ISO 11359-1/-2 ISO 11359-1/-2

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Coeff. of linear therm. expansion, Normal, 55-160°C RTI, electrical, 0.4mm RTI, electrical, 0.75mm RTI, electrical, 1.5mm RTI, electrical, 3mm RTI, impact, 0.75mm RTI, impact, 1.5mm RTI, impact, 3mm RTI, strength, 0.75mm RTI, strength, 1.5mm RTI, strength, 3mm	100/* 140 140 140 115 115 120 125 125/* 130	E-6/K °C °C °C °C °C °C °C °C °C °C	ISO 11359-1/-2 UL 746B UL 746B
Flammability	dry/cond.		
Burning Behav. at 1.5mm nom. thickn. Thickness tested UL recognition Burning Behav. at thickness h Thickness tested UL recognition Oxygen index Glow Wire Flammability Index, 0.75mm Glow Wire Flammability Index, 3mm Glow Wire Ignition Temperature, 0.75mm Glow Wire Ignition Temperature, 0.4mm Glow Wire Ignition Temperature, 3mm FMVSS Class	V-0/* 1.5/* yes/* V-0/* 0.4/* yes/* 37/* 960/- 960/- 725/- 700/- 800/- DNI	class mm - class mm - % °C °C °C °C °C °C °C °C °C °C	IEC 60695-11-10 IEC 60695-11-10 UL 94 IEC 60695-11-10 IEC 60695-11-10 UL 94 ISO 4589-1/-2 IEC 60695-2-12 IEC 60695-2-12 IEC 60695-2-13 IEC 60695-2-13 IEC 60695-2-13 IEC 60695-2-13 IEC 60695-2-13 IEC 60695-2-13
Electrical properties	dry/cond.		
Relative permittivity, 100Hz Relative permittivity, 1MHz Dissipation factor, 100Hz Dissipation factor, 1MHz Volume resistivity Surface resistivity Electric strength Comparative tracking index Electric Strength, Short Time, 2mm Dielectric Constant, 1 GHz Dielectric Constant, 10 GHz Dissipation Factor, 10 GHz	4.1/- 3.9/- 65/- 120/- >1E13/5E11 */>1E15 36/- 600/- 26/- 3.7/- 3.8/- 110/- 100/-	- E-4 E-4 Ohm.m Ohm kV/mm - kV/mm - E-4 E-4	IEC 62631-2-1 IEC 62631-2-1 IEC 62631-2-1 IEC 62631-2-1 IEC 62631-3-1 IEC 62631-3-2 IEC 60243-1 IEC 60243-1 IEC 60243-1 ASTM D 2520 B ASTM D 2520 B ASTM D 2520 B

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Other properties	dry/cond.	
Density	1440/- kg/m³	ISO 1183
VDA Properties		
Odour	3.5 class	VDA 270
Injection		
Drying Recommended	yes	
Drying Temperature	100 °C	
Drying Time, Dehumidified Dryer	6-8 h	
Processing Moisture Content	≤0.1 %	
Min. melt temperature	320 °C	
Max. melt temperature	325 °C	
Min. mould temperature	90 °C	
Max. mould temperature	130 °C	

Characteristics

Additives

Release agent, Flame retardant, Non-halogenated/Red phosphorous free flame retardant

Additional Information

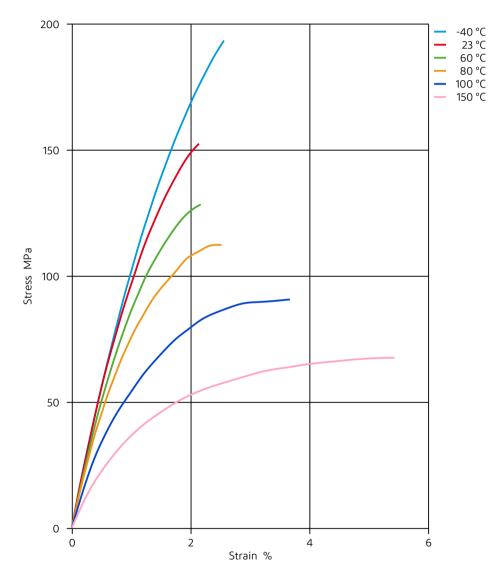
Injection molding

For molding machine components, use corrosion resistant and wear resistant steel. For details please contact your DuPont representative. Limit the residence time of the resin in the machine. Use proper protective equipment and adequate ventilation.



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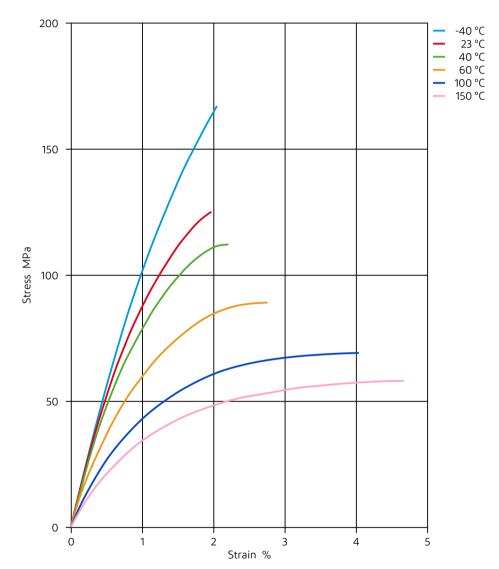
Stress-strain (dry)





HIGH PERFORMANCE POLYAMIDE RESIN

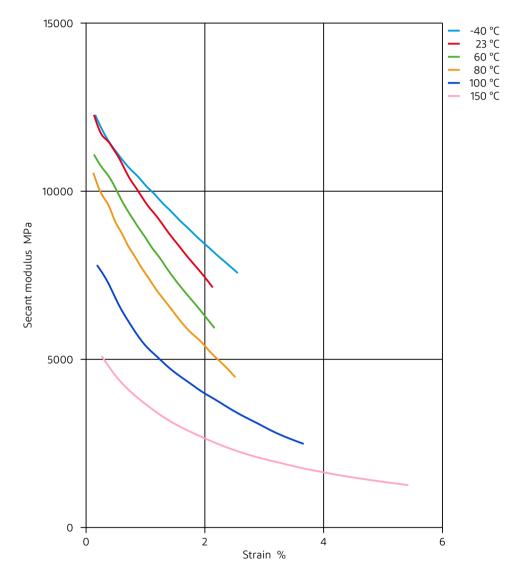
Stress-strain (cond.)





HIGH PERFORMANCE POLYAMIDE RESIN

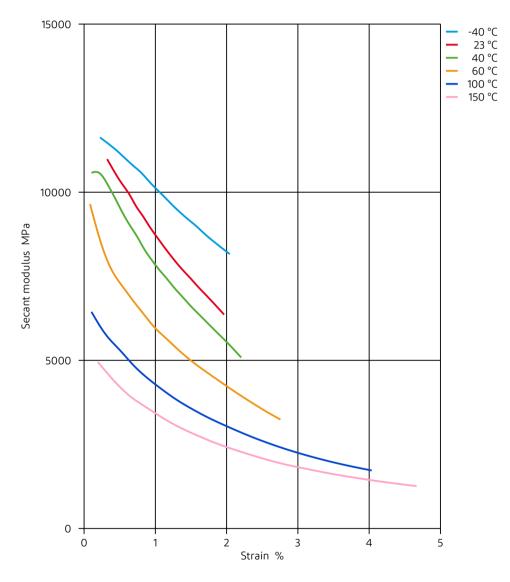
Secant modulus-strain (dry)





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Secant modulus-strain (cond.)



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